

Conference Introduction



2019 International Conference on Functional Materials and Applied Technologies (FMAT 2019) will be held in Nanjing University of Science and Technology, China during June 24-26, 2019.

FMAT 2019 aims to foster and conduct collaborative interdisciplinary research in state-of-the-art methodologies and technologies within Functional Materials and Applied Technologies. The meeting aims to attract participants with different backgrounds, to foster cross-pollination between different research fields, and to expose and discuss innovative

theories, frameworks, methodologies, tools, and applications.

Good News

1. Famous professors as Speakers

Prof. Shen-Ming Chen, National Taipei University of Technology, Taiwan;

Prof. Sarawut Rimdusit, Chulalongkorn University, Bangkok, Thailand;

2. Publication

International Journal of Material, Mechanics and Manufacturing (IJMMM ISSN: 1793-8198) which will be indexed by Chemical Abstracts Services (CAS), Engineering & Technology Digital Library, ProQuest, Crossref, Ulrich's Periodicals Directory, DOAJ, and Electronic Journals Library.

3. Academic Visit

There will be a one-day academic visit in Nanjing on June 26, 2019.

Submission Methods:

1. Electronic Submission System:

<http://confsys.iconf.org/submission/fmat2019>

2. Conference Email Address: fmat@cbees.org

Contact us: Conference Specialist: Ms. Xue Gong

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Contact Tel: +852-3500-0137 (Hong Kong)

Important Dates

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Paper Submission	before March 25, 2019
Notification of Acceptance	on April 15, 2019
Registration	before May 05, 2019
Conference Dates	June 24-25, 2019
Academic Visit	June 26, 2019

Call for Papers

Topics of interest for submission include, but are not limited to: **New Materials and Functional Materials** -- Non-ferrous Metal material, Iron and Steel, Composites, Micro / Nano Materials, Optical/Electronic/Magnetic Materials, New Functional Materials, Building Materials, New Energy Materials, Environmental Friendly Materials, Earthquake Materials and Design, Biomaterials, Smart/Materials Intelligent Systems, Polymeric Materials, Mechanical Behavior & Fracture, Tooling Testing and Evaluation of Materials; **Electronic Materials** -- Electronic Materials, Semiconductor Materials, Display Materials, Battery Materials, Optical Materials, Dielectric Materials, Ferroelectric Materials, Conductive Metal; **Materials Processing Engineering** -- Materials Processing Engineering Metallurgy Technology, Polymer Materials, Polymer Processing, Metalworking, Casting, Welding and other related fields. (For more information, please visit <http://www.icccp.org/cfp.html>)

